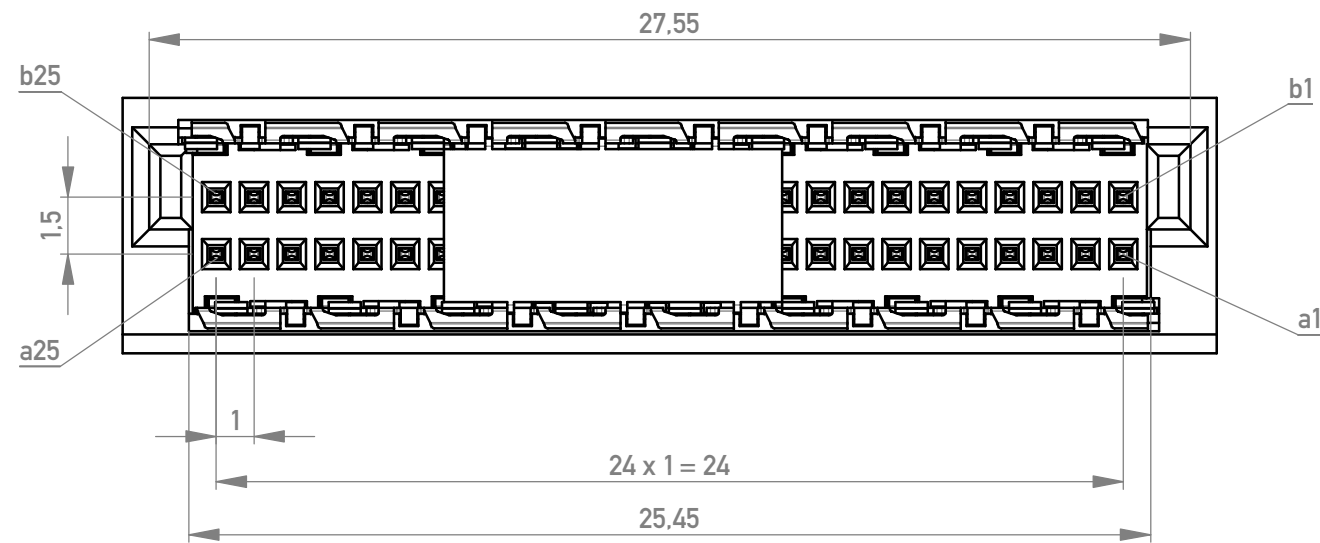
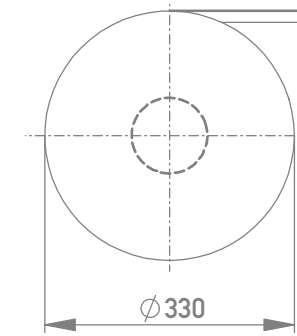
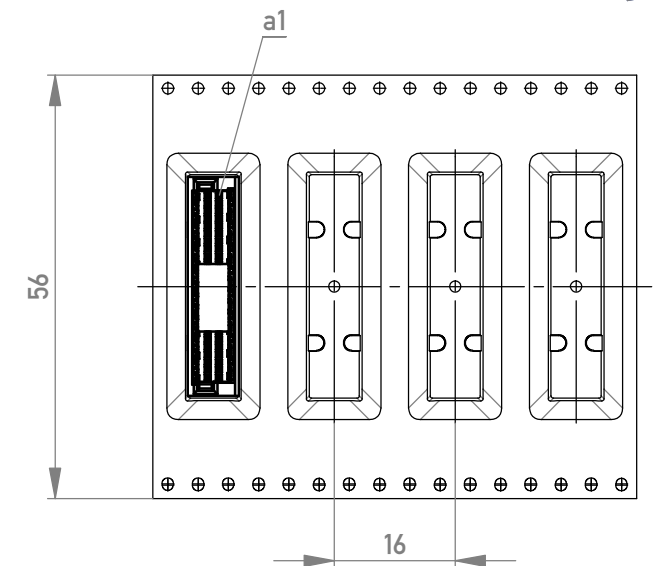


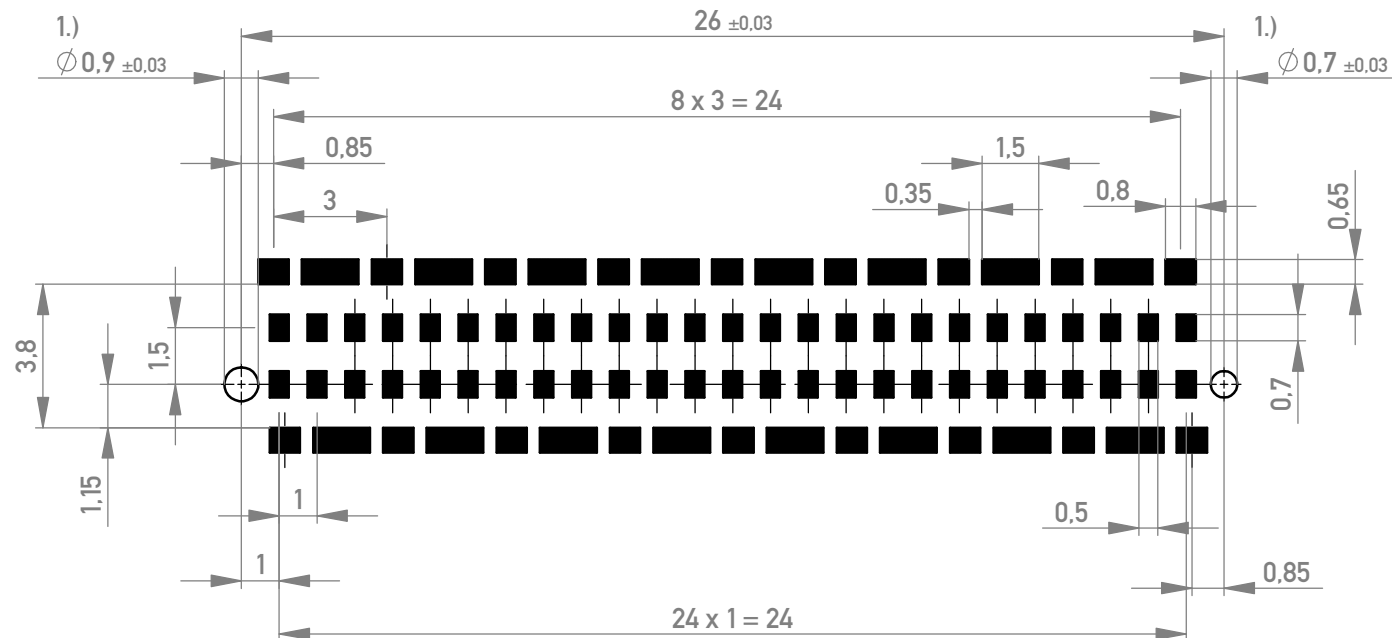
Verpackt im Gurt nach DIN IEC 60286-3
 Tape on Reel Packaging according to DIN IEC 60286-3
 Verpackungseinheit: 400 Stück
 Packaging unit: 400 pcs



Abspulrichtung - Reel off Direction



Leiterplatten-Layout Vorschlag / PCB-layout proposal



Anforderungsstufe 1
 Performance Level 1

Kontaktbereich vergoldet
 Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
 Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0.1 mm
 Coplanarity Area of Termination ≤ 0.1 mm

1.) Durchmesser des Bohrers / Drill tool

Für weitere Layout Details
 bitte Applikations Schrift
 MicroSpeed beachten.
 For further layout details
 please consider
 MicroSpeed application note.

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| | | | | |
|--|------|---|----------------------|---|
| Information: | | Tolerances | All Dimensions in mm | Scale 5:1 |
| All rights reserved. Only for Information. To ensure that this is the latest version of this drawing, please contact one of the ERNI companies before using. | | Subject to modification without prior notice. Drawing will not be updated. | | Designation Messerl. 1mm SMD 50pol. BM EMV Male 1mm SMD 50 cont. BM EMV |
| e | | 28.01.2014 | | www.ERNI.com |
| Index | Date | | | |
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| Class | | | | MSPEED |